# Table of contents

## CHAPTER 1 INTRODUCTION

1.1 Features of Mini DIPIPM Ver.7 ........................................................................................................ 2
1.2 Functions ...................................................................................................................................... 2
1.3 Target Applications ..................................................................................................................... 3
1.4 Product Line-up ........................................................................................................................... 3
1.5 The Differences between Previous Series and This Series .......................................................... 4

## CHAPTER 2 SPECIFICATIONS AND CHARACTERISTICS

2.1 Mini DIPIPM Ver.7 Specifications

2.1.1 Maximum Ratings......................................................................................................................... 6
2.1.2 Thermal Resistance......................................................................................................................... 8
2.1.3 Electric Characteristics and Recommended Conditions .......................................................... 9
2.1.4 Mechanical Characteristics and Ratings ................................................................................... 11

2.2 Protective Functions and Operating Sequence

2.2.1 Short Circuit Protection .............................................................................................................. 12
2.2.2 Control Supply UV Protection .................................................................................................. 14
2.2.3 Temperature output function V<sub>tr</sub> ....................................................................................... 16

2.3 Package Outlines

2.3.1 Package outlines ......................................................................................................................... 21
2.3.2 Marking .................................................................................................................................... 22
2.3.3 Terminal Description .................................................................................................................. 23

2.4 Mounting Method

2.4.1 Electric Spacing .......................................................................................................................... 25
2.4.2 Mounting Method and Precautions .......................................................................................... 25
2.4.3 Soldering Conditions ............................................................................................................... 27

## CHAPTER 3 SYSTEM APPLICATION GUIDANCE

3.1 Application Guidance

3.1.1 System connection ....................................................................................................................... 28
3.1.2 Interface Circuit (Direct Coupling Interface example for using one shunt resistor) .................. 29
3.1.3 Interface Circuit (Example of Opto-coupler Isolated Interface) ................................................. 30
3.1.4 External SC Protection Circuit with Using Three Shunt Resistors ......................................... 31
3.1.5 Circuits of Signal Input Terminals and Fo Terminal ................................................................. 31
3.1.6 Snubber Circuit ........................................................................................................................... 33
3.1.7 Recommended Wiring Method around Shunt Resistor ............................................................... 33
3.1.8 Precaution for Wiring on PCB .................................................................................................. 35
3.1.9 Parallel operation of DIPIPM .................................................................................................... 36
3.1.10 SOA of Mini DIPIPM ................................................................................................................ 36
3.1.11 SC50A ..................................................................................................................................... 37
3.1.12 Power Life Cycles .................................................................................................................... 38

3.2 Power Loss and Thermal Dissipation Calculation

3.2.1 Power Loss Calculation .............................................................................................................. 39
3.2.2 Temperature Rise Considerations and Calculation Example ................................................... 41
3.2.3 Installation of thermocouple ..................................................................................................... 42

3.3 Noise and ESD Withstand Capability

3.3.1 Evaluation Circuit of Noise Withstand Capability .................................................................. 43
3.3.2 Countermeasures and Precautions .......................................................................................... 43
3.3.3 Static Electricity Withstand Capability ..................................................................................... 44

## CHAPTER 4 Bootstrap Circuit Operation

4.1 Bootstrap Circuit Operation .......................................................................................................... 45
4.2 Bootstrap Supply Circuit Current at Switching State ................................................................... 46
4.3 Note for designing the bootstrap circuit ..................................................................................... 47
4.4 Initial charging in bootstrap circuit ............................................................................................. 48

## CHAPTER 5 Interface Demo Board

5.1 Super mini DIPIPM Ver.7 Interface Demo Board ......................................................................... 49
5.2 Circuit Schematic, Parts List and Board pattern ........................................................................ 51

## CHAPTER 6 PACKAGE HANDLING

6.1 Packaging Specification .................................................................................................................. 53
6.2 Handling Precautions ................................................................................................................... 54